

DMOS Full-Bridge Motor Driver

Features and Benefits

- Single supply operation
- Very small outline package
- Low R_{DS(ON)} outputs
- Sleep function
- Internal UVLO
- Crossover current protection
- Thermal shutdown protection

Packages:



Package LB, 16-pin SOIC with internally fused pins



Package LP, 16-pin TSSOP with exposed thermal pad

Not to scale

Description

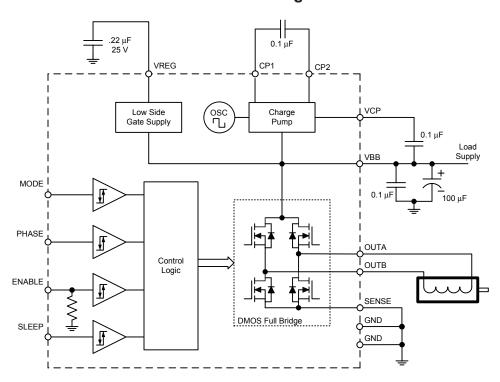
Designed for PWM (pulse width modulated) control of dc motors, the A3949 is capable of peak output currents to ± 2.8 A and operating voltages to 36 V.

PHASE and ENABLE input terminals are provided for use in controlling the speed and direction of a dc motor with externally applied PWM control signals. Internal synchronous rectification control circuitry is provided to reduce power dissipation during PWM operation.

Internal circuit protection includes thermal shutdown with hysteresis, undervoltage monitoring of $V_{\rm BB}$ and $V_{\rm CP}$, and crossover current protection.

The A3949 is supplied in a choice of two power packages, a 16-pin plastic SOIC with a copper batwing tab (part number suffix LB), and a low profile (1.1mm) 16-pin TSSOP (suffix LP) with exposed power tab. Both packages are lead (Pb) free, with 100% matte tin leadframes.

Functional Block Diagram



Selection Guide

Part Number	Package	Packing
A3949SLBTR-T	16-pin, SOIC	1000 per reel
A3949SLPTR-T*	16-pin, TSSOP	4000 per reel

^{*}Variant is in production but has been determined to be NOT FOR NEW DESIGN. This classification indicates that sale of the variant is currently restricted to existing customer applications. The variant should not be purchased for new design applications because obsolescence in the near future is probable. Samples are no longer available. Status change: May 4, 2009. Recommended alternative: <u>A3950</u>.

Absolute Maximum Ratings

Characteristic	Symbol	Notes	Rating	Units
Load Cupply Voltage			36	V
Load Supply Voltage	V _{BB}	Peak < 2 µs	38	V
Logic Input Voltage	V _{IN}		-0.3 to 7	V
Sense Voltage	V _{SENSE}		0.5	V
Output Current, Repetitive	Гоит	Output current rating may be limited by duty cycle, ambient temperature, and heat sinking. Under any set of conditions, DO NOT exceed the specified I_{OUT} or T_{J} .	±2.8	А
Operating Ambient Temperature	T _A	Range S	–20 to 85	°C
Maximum Junction Temperature	T _J (max)		150	°C
Storage Temperature	T _{stg}		-55 to 150	°C

Package Thermal Characteristics*

Characteristic	Symbol	Note	Rating	Units
Package Thermal Resistance	$R_{_{\theta JA}}$	LB package, measured on 2-layer PCB with 2 in? 2-oz. copper each side	52	°C/W
		LP package, measured on 4-layer PCB based on JEDEC standard	34	°C/W

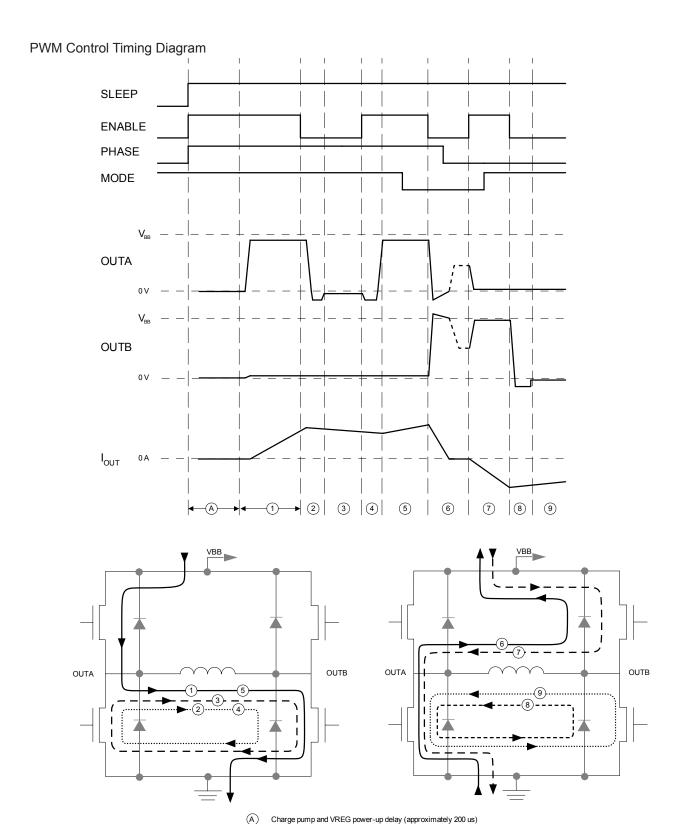
^{*}Additional information is available on the Allegro website



ELECTRICAL CHARACTERISTICS at T_A = 25°C, V_{BB} = 8 V to 36 V (unless otherwise noted)

Characteristics	Symbol	Test Conditions		Тур.	Max.	Units	
		Source driver, $I_{OUT} = -2.8 \text{ A}$, $T_{J} = 25^{\circ}\text{C}$	_	.4	.48	Ω	
Output-On Resistance	R _{dson}	Source driver, I _{OUT} = -2.8 A, T _J = 125°C		.68	_	Ω	
		Sink driver, I _{OUT} = 2.8 A, T _J = 25°C	_	.3	.43	Ω	
		Sink driver, $I_{OUT} = -2.8 \text{ A}$, $T_J = 125^{\circ}\text{C}$	_	.576	_	Ω	
Dady Diada Faryard Valtage	V _F	Source diode, I _F = -2.8 A	_	1.1	1.3	V	
Body Diode Forward Voltage		Sink diode, I _F = 2.8 A	_	1	1.3	V	
		f _{PWM} < 50 kHz	_	6	8.5	mA	
Motor Supply Current	l _{BB}	Charge pump turned on; outputs disabled	_	3	4.5	mA	
		Sleep mode	_	_	10	μΑ	
Logic Input Voltage	V _{IN(1)}		2.0	_	_	V	
PHASE, ENABLE, MODE	V _{IN(0)}		_	_	0.8	V	
Logic Input Voltage	V _{IN(1)}		2.7	_	_	V	
SLEEP	V _{IN(0)}		_	_	0.8	V	
Logic Input Current	I _{IN(1)}	V _{IN} = 2.0 V	_	< 1.0	20	μΑ	
PHASE, MODE pins	I _{IN(0)}	V _{IN} = 0.8 V	_	<-2.0	-20	μΑ	
Logic Input Current	I _{IN(1)}	V _{IN} = 2.0 V	_	40	100	μΑ	
ENABLE pin	I _{IN(0)}	V _{IN} = 0.8 V	_	16	40	μΑ	
Logic Input Current	I _{IN(1)}	V _{IN} = 2.7 V	_	27	50	μΑ	
SLEEP pin	I _{IN(0)}	V _{IN} = 0.8 V	_	< 1	10	μΑ	
Dranagation Daloy Times	t _{pd}	From PWM change to source or sink turn on	_	600	_	ns	
Propagation Delay Times		From PWM change to source or sink turn off	_	100	_	ns	
Crossover Delay	t _{COD}		_	500	_	ns	
Protection Circuitry							
UVLO Enable Threshold		VBB rising	_	6	_	V	
UVLO Hysteresis			_	250	_	mV	
Thermal Shutdown Temp.	T_{J}		_	170	_	°C	
Thermal Shutdown Hysteresis	$\DeltaT_{_{J}}$		_	15	_	°C	







Functional Description

VREG. This supply voltage is used to operate the sink-side DMOS outputs. VREG is internally monitored and in the case of a fault condition, the outputs of the device are disabled. The VREG pin should be decoupled with a 0.22 μF capacitor to ground.

Charge Pump. The charge pump is used to generate a supply above VBB to drive the source-side DMOS gates. A 0.1 uF ceramic monolithic capacitor should be connected between CP1 and CP2 for pumping purposes. A 0.1 uF ceramic monolithic capacitor should be connected between VCP and VBB to act as a reservoir to run the high side DMOS devices. The VCP voltage is internally monitored, and in the case of a fault condition, the outputs of the device are disabled.

Shutdown. In the event of a fault due to excessive junction temperature, or low voltage on VCP or VREG, the outputs of the device are disabled until the fault condition is removed. At power-up, the UVLO circuit disables the drivers.

Sleep Mode. Control input SLEEP is used to minimize power consumption when the A3949 is not in use. This disables much of the internal circuitry, including the low-side gate supply and the charge pump. A logic low on this pin puts the device into Sleep mode. A logic high allows normal operation. After coming out of Sleep mode, the user should wait 1 ms before applying PWM signals, to allow the charge pump to stabilize.

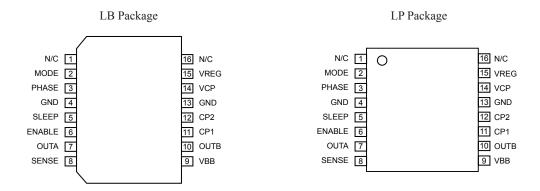
Braking. The braking function is implemented by driving the device in slow decay mode via the MODE pin, and applying an enable chop command. Because it is possible to drive current in both directions through the DMOS switches, this configuration effectively shorts out the motor-generated BEMF, as long as the enable chop mode is asserted on the ENABLE pin. The maximum current can be approximated by $V_{\text{BEMF}}/R_{\text{L}}$. Care should be taken to insure that the maximum ratings of the device are not exceeded in worse case braking situations of high speed and high inertial loads.

Control Logic Table

PHASE	ENABLE	MODE	SLEEP	OUTA	OUTB	Function	
1	1	Χ	1	Н	L	Forward	
0	1	Χ	1	L	Н	Reverse	
Х	0	1	1	L	L	Brake (slow decay)	
1	0	0	1	L	Н	Fast decay SR*	
0	0	0	1	Н	L	Fast decay SR*	
Х	Х	Х	0	Hi-Z	Hi-Z	Sleep mode	

^{*} To prevent reversal of current during fast decay SR (synchronous rectification), the outputs go to the high impedance state as the current approaches zero.



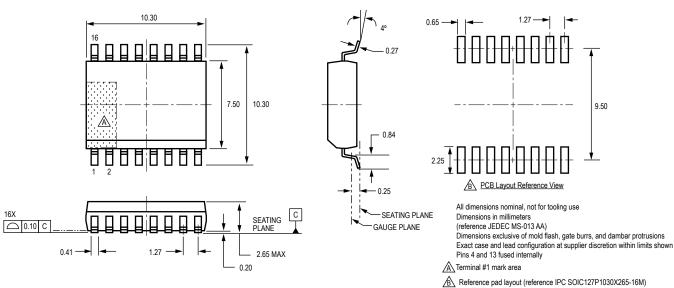


Name	Description	Number			
Name	Description	TSSOP-16	SOIC-16		
N/C	Not used	1	1		
MODE	Logic input	2	2		
PHASE	Logic input for direction control	3	3		
GND	Ground	4*	4*		
SLEEP	Logic input	5	5		
ENABLE	Logic input	6	6		
OUTA	Output A for full bridge	7	7		
SENSE	Power return	8	8		
VBB	Load supply voltage	9	9		
OUTB	Output B for full bridge	10	10		
CP1	Charge pump capacitor	11	11		
CP2	Charge pump capacitor	12	12		
GND	Ground	13*	13*		
VCP	Reservoir capacitor	14	14		
VREG	Low side gate supply decoupler	15	15		
N/C	Not used	16	16		

^{*}For the TSSOP package, connect pins 4 and 13 to the exposed thermal pad via the PCB layout. In the SOIC package, the pins are internally connected.

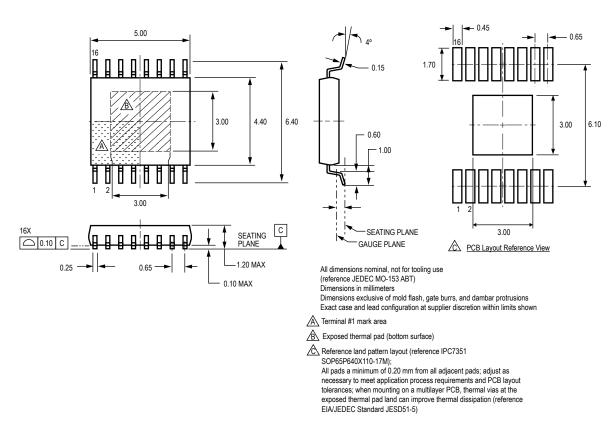


LB 16-Pin SOICW



Keterence pad layout (reterence IPC SOIC12/P1030X265-16M)
All pads a minimum of 0.20 mm from all adjacent pads; adjust as necessary to meet application process requirements and PCB layout tolerances

Package LP 16-Pin TSSOP



A3949

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